

PARA LIGHT ELECTRONICS CO., LTD.

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DATA SHEET

PART NO.: EP505L-350HG1

REV: <u>A/0</u>

CUSTOMER'S APPROVAL : _____ DCC : ____

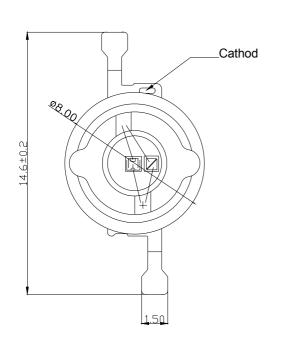


EP505L-350HG1

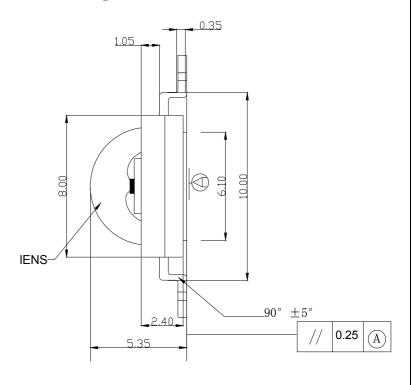
REV:A/0

PACKAGE DIMENSIONS

TOP VIEW



SIDE VIEW



Notes:

- 1. All dimensions are in millimeters.
- 2. Tolerance is \pm 0.25mm (.020") unless otherwise

Features

- * HIGHEST FLUX PER LED IN THE WORLD
- * VERY LONG OPERATING LIFE
- * MORE ENERGY EFFICIENT THAN INCANDESCENT AND MOST HALOGEN LAMPS
- * LOW VOLTAGE DC OPERATED
- * COOL BEAM SAFE TO THE TOUCH
- * INSTANT LIGHT (LESS THAN 100NS)
- * NO UV



EP505L-350HG1

REV:A/0

Chip Materials

Dice Material : InGaNLight Color : GREENLens Color : Water Clear

Absolute Maximum Ratings(Ta=25℃)

Symbol	Parameter	Rating	Unit
lF	DC Forward Current	350	mA
Ipulse	Peak pulse current;	500	mA
	(tp ≤ 100us, Duty cycle=0.25)	300	
VR	Reverse Voltage	5	V
lr	Reverse Current(Vr=5V)	50	uA
Tj	LED junction Temperature(at 350mA)	125	$^{\circ}\!\mathbb{C}$
*Topr	Operating Temperature	-30 ~ +100	$^{\circ}\!\mathbb{C}$
*Tstg	Storage Temperature	-40 ~ +100	$^{\circ}\!\mathbb{C}$
Tsol	Manual Soldering Time at 260 ℃ (Max.)	5	seconds

Note:

HBM : Human Body Model. Seller gives no other assurances regarding the ability of to withstand ESD.

Electro-Optical Characteristics(Ta=25 °C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Condition
Luminous Intensity	IV	29	72		lm	IF=350mA/100ms
Viewing Angle	2 θ 1/2		130		deg	Note 2
Peak Emission	λn		510	nm	Measurement	
Wavelength	λр	510	310		nm	@Peak
Dominant Wavelength	λd		515		nm	IF=350mA
Spectral Line	pectral Line Δλ		30		nm	
Half-Width	$\Delta \lambda$		30		nm	
Forward Voltage	VF	3.23	4.0	5.06	V	IF =350mA
Reverse Current	IR			100	μ А	VR = 5V

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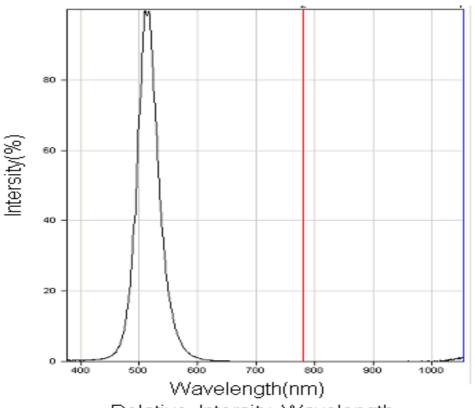
^{* :} Temperature for using with aluminum board.



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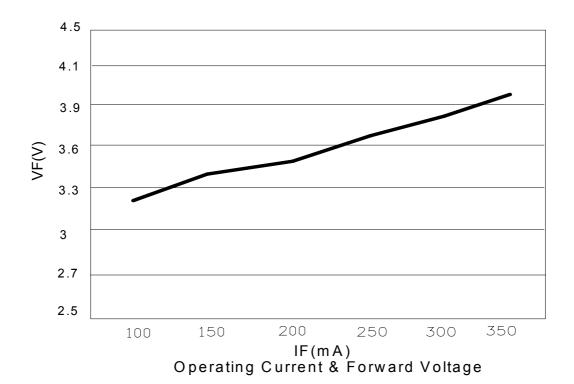
REV:A/0

Typical Optical and Electrical



Wp=509.51nm Wd=514.73nm Hw=38.92nm Purity=0.655

Relative Intersity Wavelength

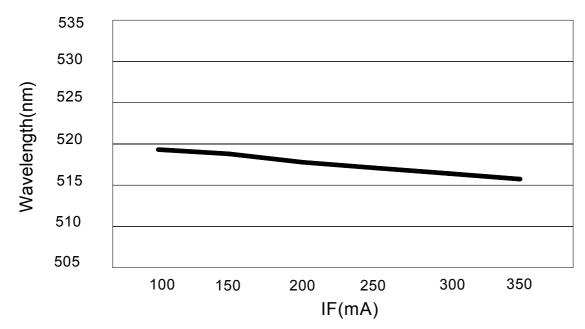




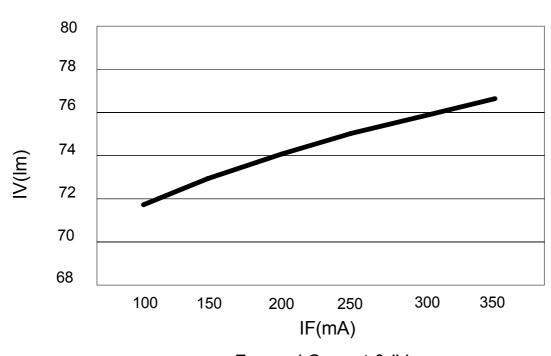
EP505L-350HG1

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Typical Optical and Electrical



Forward Current & Wavelength



Forward Current & IV

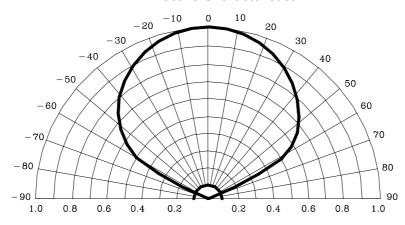


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REV:A/0

Typical Optical and Electrical



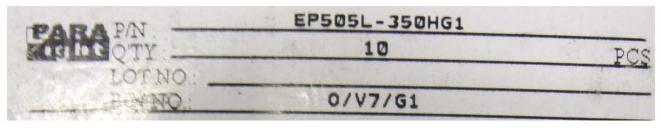


Operating conditions:

- 1. 350mA operating condition under f=1K Hz and 1/2 duty cycle.
- 2. 1000mW: 2pins and Slug independent of E-Power LED must be mounted on PCB.

(PCB: ⊄ 19.9mm 1.6t / two layers / 2.0 oz)

Label Explanation



PART NO: EP505L-350HG1

LOT NO: E L E 6 5 0002 A B C D E F

A---E: For series number B---L: Local F: Foreign

C---E: EPOWER

D---Year

E---Month

F---SPEC.

BIN NO: BIN CODE

QUANTITY: (Below are standard specification, actual packing quantity reference page 6)

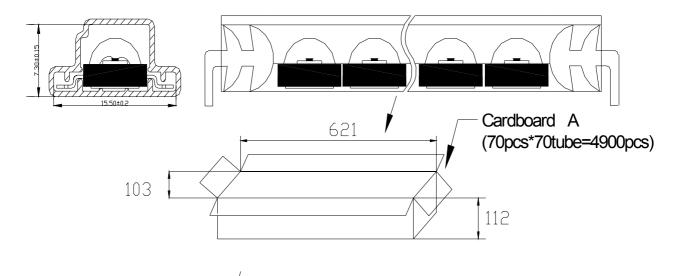
70pcs for one tube, 70 tubes in a box(70*70=4900pcs).

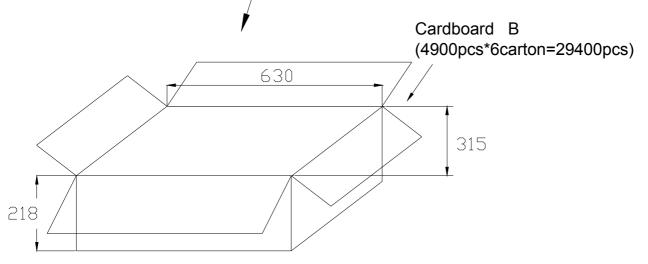


EP505L-350HG1

REV:A/0

PACKING SPECIFICATIONS





Notes:

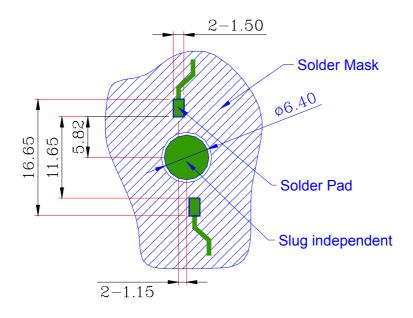
- 1.All dimensions are in millimeters.
- 2. Normal packing Quantity: 4900pcs.
- 3. The carton B contains 6 carton A at maximum.



EP505L-350HG1

REV:A/0

Suggest Soldering Pad Dimensions



Note:

- 1. All dimensions are in mm
- 2. The drawings are not to scale
- 3. Solder pad can't be connected to slug.

Bin Code List

Luminous Intensity(IV), Unit:Im@350mA				
Bin Code	Min	Max		
W	29	46		
X	38	60		
Y	49	78		
Z	64	101		

Forward Voltage(VF), Unit:V@350mA				
Bin Code	Min	Max		
V5	3.23	4.60		
V6	3.40	4.83		
V7	3.57	5.06		

Including test tolerance

Including test tolerance

Dominant Wavelength (Hue),Unit: nm@350mA			
Bin Code	Min	Max	
G0	509	516	
G1	514	521	
G2	519	526	

Including \pm 1nm test tolerance

PARA ight

Enhance Power LED

EP505L-350HG1

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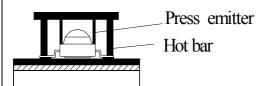
CAUTIONS

1. Typical Application

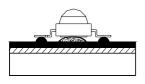
Reading Light / Flashlight / Track Lighting/Under Shelf / Task Lighting Emergency Lighting / Traffic Signals/Bollards / Security / Garden Lighting

2. Soldering

Recommend Solder Steps



Hot bar soldering

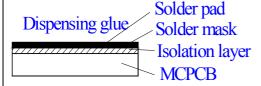


Emitter put on the glue



Dispensing Flux





Notes:

- 1. MCPCB material with a thermal conductivity greater than 2.0 W/mk.
- 2. Solder pad can't be connected to slug.
- 3. The Thermal glue should be as thin as possible for better heat conductivty.
- 4. During any assembly process touching lens is avoided. This will cause pollution or scratch on the surface of lens.



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E-POWER OPERATING PROCEDURE

- 1. E-power 350 series should be operated at 350 mA for ideal performance, but not more than 360mA.
 - 2. Ep5 can't be soldered with solder paste using reflow process. The suggested soldering temperature in the data sheet.
 - 3. Blue, Cyan, Green and White colors must be used in conjunction with heat-sinking devices. Soldering on Al PCB with mid-connection point while keeping the layout pattern (⊄ 19.9mm) is another way to help heat dissipation. Thermal Resistance for aluminum board must be less than 0.65 °C/W.
 - 4. Please be aware that the mid-connection point for Red and Amber is negative-polarity while it is non-polarity in Blue, Cyan, Green and White.
 - 5. E-power products are sensitive to static, especially in Blue, Cyan, Green. Operators must wear static wristband (wireless static wristband is prohibited) and be well grounded while working in the environment with an ionizing air blower. Anti-static requirement should be under ESD 400V.
 - 6. E-power products are fully tested and shipped in anti-static packaging.
 - 7. A non-conductive heat-dissipating paste should be applied between E-power and heat-sinking device.
 - 8. It is recommended to design circuit in series with protected IC to limit current flow. In a parallel connection, each IC should be protected individually.



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Reliability Test

Classification	Test Item	Test Condition	Reference Standard	Units Tested	Units Failed
Endurance Test	High Temperature High Humidity Storage 1	In-Board, 1 Times Ta= 85±5℃,RH= 90∼95% Current =45mA *Test Time= 1000HRS±2HRS		22	0
	High Temperature High Humidity Storage 2	In-Board, 1 Times Ta= 85±5℃,RH= 90∼95% Reverse Voltage=5V *Test Time= 1000HRS±2HRS		22	0
	Life test 1	Ta= 55±5°C Current =70mA *Test Time=1000HRS		22	0
	Life test 2	Ta= -40±5°C Current =70mA *Test Time=1000HRS		22	0
Environmental Test	Temperature Cycling 1	In-Board, 1 Times 100±5℃ -55±5℃ 15mins DWELL 5nin 20 Cycles 100 Cycles	MIL-STD-883 METHOD 1010	22	0
	Temperature Cycling 2	In-Board, 1 Times 120±5℃ -40±5℃ 15mins DWELL 5nin 20 Cycles 100 Cycles	MIL-STD-883 METHOD 1010	22	0



EP505L-350HG1

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PART NO. SYSTEM OF E-POWER LED
 EP 5 05 L – 350HG1– A

Aluminum Board: MPST-EVT01-161

λ **d**:

R1: (Typ) =620nm Y1:(Typ)=595nm HG1: (Typ) =515nm B1:(Typ)= 460nm

IR4: (Typ) =850nm

CURRENT:

35 : 20mA 150:150mA 350:350mA 700:700mA

VIEWING ANGLE:

2: 2*5=10° L : L*5=130° 3:3*5=15° 6 : 6*5=30°

M: M*5=160° C: C*5=60° K: K*5=100°

PACKAGE TYPE:

03:5mm LENS 04:11mm LENS

06: Additional photics LENS

2:YEAR 2002 4:YEAR 2004 5:YEAR 2005

EP:E-Power LED

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